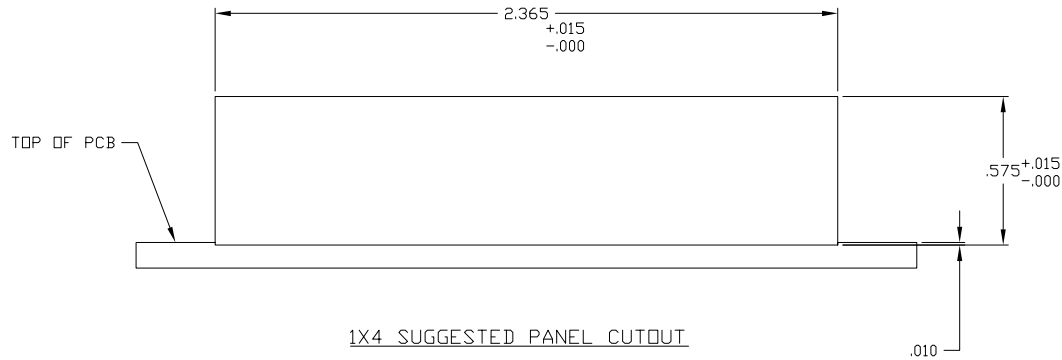
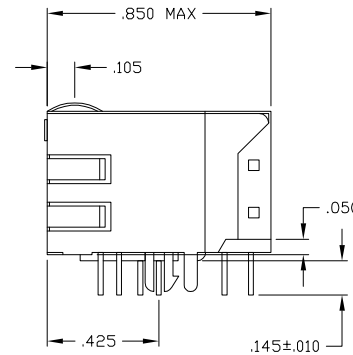
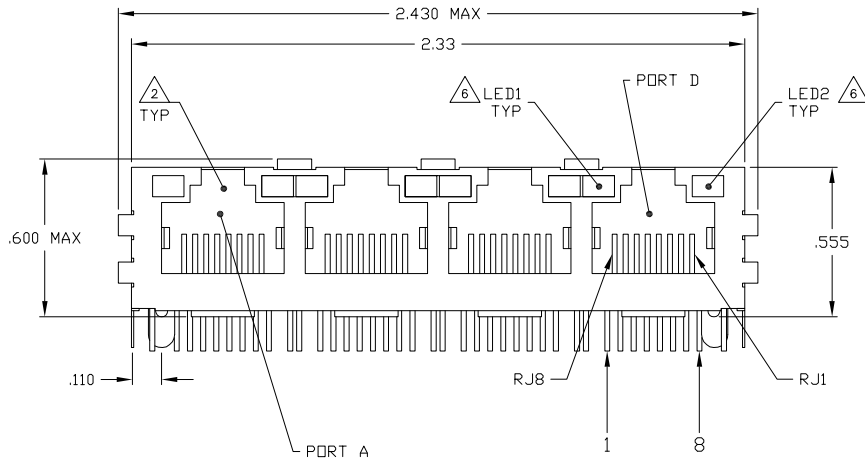
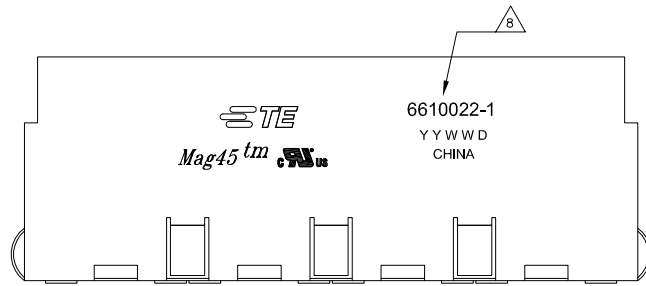


MECHANICAL:



- 1 MATERIALS:
 -HOUSING - THERMOPLASTIC PET POLYESTER FLAMMABILITY RATING UL 94V-0.
 -SHIELD - .010" THICK, C26800 BRASS PREPLATED WITH 30μINCH MIN SEMI-BRIGHT NICKEL.
 -SOLDER TABS POST DIPPED WITH 100μINCH MIN SAC SOLDER.
 -MOD JACK CONTACTS - 0.0157 X 0.018" PHOSPHOR BRONZE, 50μINCH MIN OVERALL NICKEL UNDERPLATE WITH SELECT 50μINCH MIN HARD GOLD FINISH PLATE. SOLDERTAILS WITH 100μINCH MIN MATTE TIN AND/OR SAC SOLDER DIP.
 -LIGHT EMITTING DIODE(LED) - DIFFUSED EPOXY LENS, .020" X .020" CARBON STEEL WIREFRAME LEADS PRE-PLATED WITH 80μINCH SILVER OVER 40μINCH NICKEL UNDERPLATE OVER 40μINCH COPPER UNDERPLATE. POST-PLATED WITH 100μIN MIN MATTE TIN AND/OR SAC SOLDER DIP OR PURE TIN SOLDER DIP.
- 2 RJ45 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUB PART F.
- 3 MAGNETICS
 -APPLICATION: 10/100 BASE-T
 -IMPEDANCE: 100 OHMS
 -TURNS RATIO (CHIP-CABLE): TX = 1:1, RX = 1:1
 -OPEN CIRCUIT INDUCTANCE (OCL): 350μH MIN @100kHz, 0.1VRMS, 8mADC BIAS FROM 0°C TO 70°C, TX AND RX
 -PERFORMANCE @ 25°C:
 INSERTION LOSS (IL): 1.1dB MAX FROM 0.5MHz TO 100MHz
 RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 30MHz
 18-20LOG(f/30)dB MIN FROM 30.1MHz TO 60MHz
 12dB MIN FROM 60.1MHz TO 80MHz
 CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 4.0MHz
 33-20*LOG(f/50)dB MIN FROM 4.01MHz TO 100MHz
 COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz
 -ISOLATION VOLTAGE: 2250VDC (MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC AND WITH ALL PORTS CONNECTED.
- 4 C1 IS AN OPTIONAL CAPACITOR. IF NO CAPACITOR, TRACE IS CONTINUOUS. SEE TABLE FOR PRESENCE OF CAPACITOR IN DIFFERENT CONFIGURATIONS.
5. OPERATING TEMPERATURE: FROM 0°C TO +70°C.
- 6 LEDs WITH BUILT-IN RESISTOR
 LEDs ARE DRIVEN WITH 5V VOLTAGE AND THE MAX OPERATING CURRENT IS 20mA.
 LED COLOR : DOMINANT WAVELENGTH (λD): GREEN 568 nm TYP. @ VF=5V
 FORWARD CURRENT (IF): GREEN 12 mA TYP. @ VF=5V
 DOMINANT WAVELENGTH (λD): YELLOW 588 nm TYP. @ VF=5V
 FORWARD CURRENT (IF): YELLOW 13 mA TYP. @ VF=5V
- 7 INDICATED CONNECTIONS ARE FOR NIC CONFIGURATION. THE MAGNETICS ARE SYMMETRICAL AND SUPPORT AUTO-MDI/MDIX.
- 8 TE CONNECTIVITY LOGO, PART NUMBER, DATE CODE, COUNTRY OF ORIGIN AND AGENCY APPROVAL MARKING IN APPROXIMATE LOCATION SHOWN.
9. THESE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PREHEAT TEMPERATURE IS 120°C TO 160°C, 120 SECONDS TO 180 SECONDS, PEAK WAVE SOLDERING TEMPERATURE IS 260°C MAX, 10 SECONDS MAX.

YES	GREEN	GREEN	6-6610022-1
NO	GREEN	YELLOW	6610022-1
DECOUPLING CAPACITOR	LED1	LED2	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.

REV	DATE	DESCRIPTION	BY	APP
1	01MAR2003	INITIAL RELEASE	VARELA	TE CONNECTIVITY
2	01MAR2003	CHG. DIM.	FAROLE	TE CONNECTIVITY
3	01MAR2003	CHG. DIM.	FAROLE	TE CONNECTIVITY
4	01MAR2003	CHG. DIM.	FAROLE	TE CONNECTIVITY

1X4 MAG45(TM) MODULAR JACK, 7N2 SCHEMATIC, 26 SERIES CIRCUIT, OPTIONAL DECOUPLING CAPACITOR, SHIELDED, WITH RESISTOR LEADS

108-2100

100779

6610022

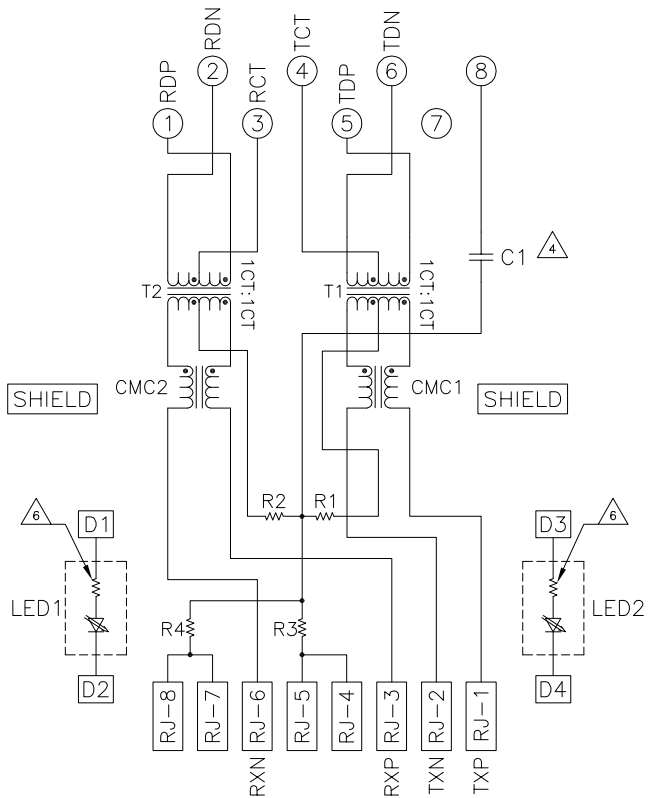
SCALE: 4:1

SHEET 1 OF 2

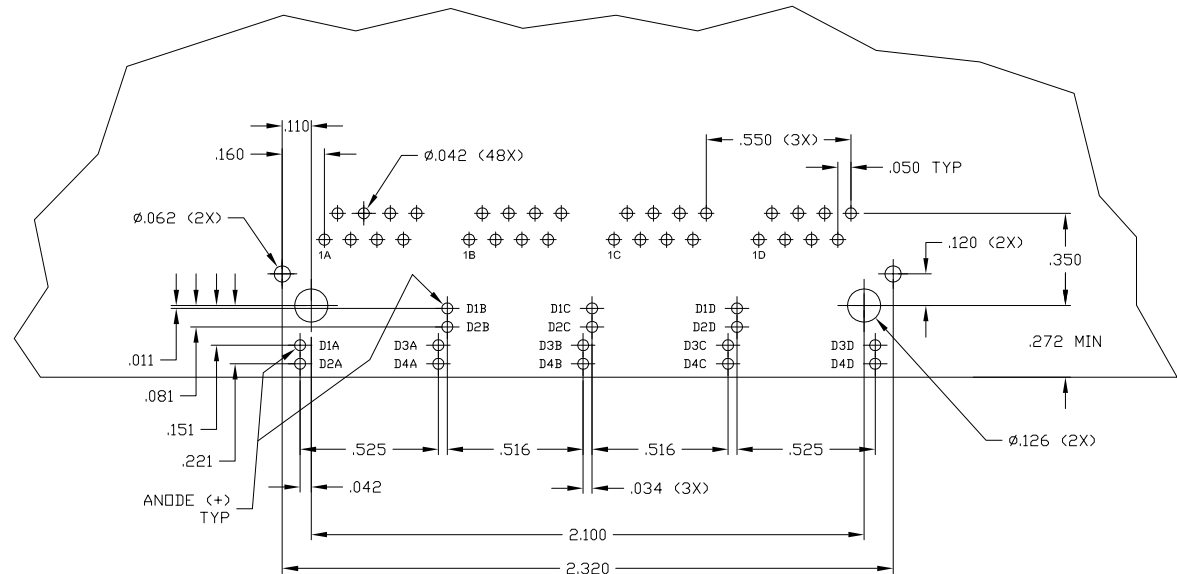
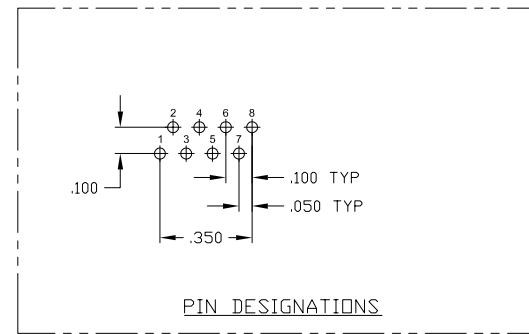
REV D

LOC		REV		REVISIONS	
AA	22			DESCRIPTION	DATE
				SEE SHEET 1	

726 SERIES MAGNETIC CIRCUIT 



C1 = 1000pF, 2kV DECOUPLING CAPACITOR
 R1-R4 = 75 OHMS, 1/16W, 5% RESISTORS



SUGGESTED PCB LAYOUT
 (Component Side)

THIS DRAWING IS A CONTROLLED DOCUMENT.		REV		DATE	
DRAWN BY: J. VARELA - 10MAR2003		CHKD BY: D. FAROLE - 10MAR2003		NAME	
DIMENSIONS: INCHES		D. FAROLE - 10MAR2003		1X4 MA645(TW) MODULAR JACK, 7N2 SCHEMATIC, 26 SERIES CIRCUIT, OPTIONAL DECOUPLING CAPACITOR, SHIELDED, WITH RESISTOR LEADS	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APPROVED BY: D. FAROLE - 10MAR2003		PRODUCT SPEC: 108-2100	
0.100 ± .010		APPLIC. SPEC: 108-2100		SIZE: A1	
0.010 ± .001		MATERIAL: -		CAGE CODE: 00779	
0.005 ± .0005		FINISH: -		DRAWING NO: C=6610022	
0.002 ± .0002		WEIGHT: -		RESTRICTED TO: -	
ANGLES: -		CUSTOMER DRAWING		SCALE: 4:1	
				SHEET 2 OF 2	
				REV D	